EMI Filter for T-Flash / MicroSD Interfaces

Description

The CM1624 is a combination EMI filter and line termination device with integrated TVS diodes for use on Multimedia Card interfaces. This state-of-the-art device utilizes solid-state, silicon-avalanche technology for superior clamping performance and DC electrical characteristics. The CM1624 has been optimized for protection of T-Flash/MicroSD interfaces in cellular phones and other portable electronics.

The CM1624 consists of six circuits that includes series impedance matching resistors and pull-up resistors as required by the SD specification. TVS diodes are included on each line for ESD protection. An additional TVS diode connection is included for protection of the voltage (Vcc) bus. Termination resistor value of 40 Ω is provided on the SDData0, SDData1, SDData2, SDData3, CMD, and CLK lines.

Pull–up resistors of 25 k Ω are included on the SDData0, SDData1, SDData2, SDData3 and CMD lines, as well. These may be configured for devices operating in SD or SPI mode. The TVS diodes provide effective suppression of ESD voltages in excess of ±15 kV (contact discharge) per IEC 61000–4–2, level 4. The CM1624 is in a 16–pin, RoHS/WEEE compliant, UDFN 16–pin package. It measures 3.30 x 1.35 x 0.50 mm. The leads are spaced at a pitch of 0.4 mm and are finished with lead–free NiPd.

Features

- Bidirectional EMI/RFI Filtering and Line Termination with Integrated ESD Protection
- Provides ESD Protection to IEC61000-4-2: ±15 kV Contact Discharge
- TVS Working Voltage: 5 V
- Termination Resistors: 40Ω
- Pull–up Resistors: 25 k Ω
- Typical Capacitance per Line: $12 \text{ pF} (V_{IN} = 2.5 \text{ V})$
- Protection and Termination for Six Lines + Vcc
- Solid-state Technology

Applications

- T-Flash / MicroSD Interfaces
- MMC Interfaces
- CDMA, GSM, 3G Cell Phones

Mechanical Characteristics

- 0.40 mm, uDFN 16-pin Package
- Nominal Dimensions: 3.30 x 1.35 x 0.50 mm
- Pitch: 0.4 mm
- Pin-lead Finish: NiPd
- RoHS/WEEE Compliance, Lead–free Finish



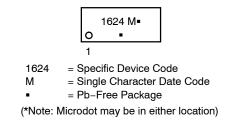
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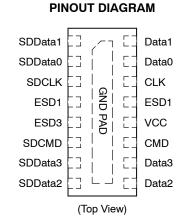
http://onsemi.com



DE SUFFIX CASE 517BE

MARKING DIAGRAM





ORDERING INFORMATION

Device	Package	Shipping [†]
CM1624-08DE	UDFN16 (Pb-Free)	3000/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL SCHEMATIC

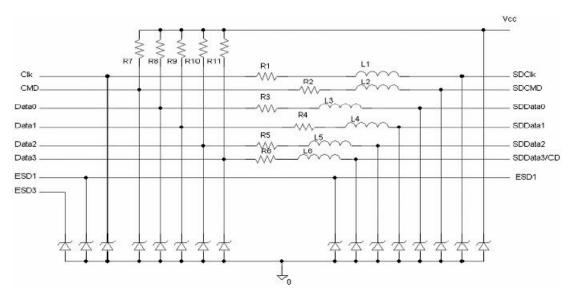


Table 1. PIN DESCRIPTIONS

Pin	Name	Description Data line #1 input/output with pull-up resistor		
1	SDData1			
2	SDData0	Data line #0 input/output with pull-up resistor		
3	SDCLK	Clock line Input/Output		
4	ESD1	Single ESD		
5	ESD3	Single ESD		
6	SDCMD	Command Line Input/Output		
7	SDData3	Data line #3 input/output with pull-up resistor		
8	SDData2	Data line #2 input/output with pull-up resistor		
9	Data2	Data line #2 input/output with pull-up resistor		
10	Data3	Data line #3 input/output with pull-up resistor		
11	CMD	Command Line Input/Output		
12	VCC	Power Supply ESD Protection		
13	ESD1	Single ESD		
14	CLK	Clock line Input/Output		
15	Data0	Data line #0 input/output with pull-up resistor		
16	Data1	Data line #1 input/output with pull-up resistor		
GND PAD	GND	Ground return to shield		

SPECIFICATIONS

Table 2. ABSOLUTE MAXIMUM RATINGS

Parameter	Rating	Units	
Operating Temperature Range	-40 to +85	°C	
Storage Temperature Range	–55 to +150	°C	

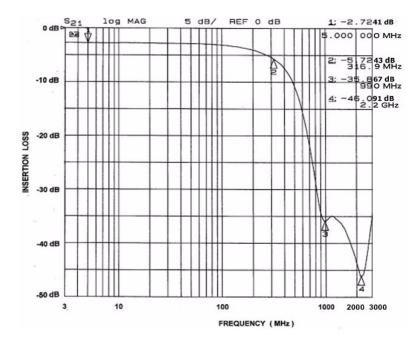
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 3. ELECTRICAL OPERATING CHARACTERISTICS (Note 1)

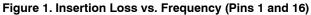
Symbol	Parameter	Conditions	Min	Тур	Max	Units
R _{CH}	Channel Resistance (R1 to R6)		34	40	46	Ω
L _{CH}	Channel Inductance			20		nH
С	Capacitance per Channel	V _{IN} = 0 V; 1 MHz; 30 mV _{RMS}	16	20	24	pF
		V _{IN} = 2.5 V; 1 MHz; 30 mV _{RMS} ; (Note 2)		12		pF
R _{UP}	Pull-up Resistance (R7 to R11)		21	25	29	kΩ
I _{LEAK}	Diode Leakage Current per Channel	V _{IN} = 3 V		0.1	0.5	μA
V _{SIG}	Signal Clamp Voltage Positive Clamp Negative Clamp	I _{LOAD} = 10 mA I _{LOAD} = -10 mA	5.6 -1.5	6.8 -0.8	9.0 -0.4	V
V _{ESD}	 ESD Protection – Peak Discharge Voltage at any channel input, in system: a) Contact discharge per IEC 61000–4–2 Standard and b) Air discharge per IEC 61000–4–2 Standard 	(Note 2) (Note 2)	±15 ±15			kV
f _C	Cut–off frequency Z_{SOURCE} = 50 Ω , Z_{LOAD} = 50 Ω			300		MHz

All parameters specified at T_A = 25°C unless otherwise noted.
 This parameter is guaranteed by design and verified by device characterization

PERFORMANCE INFORMATION



Typical Filter Performance (nominal conditions unless specified otherwise, 50 Ω Environment)



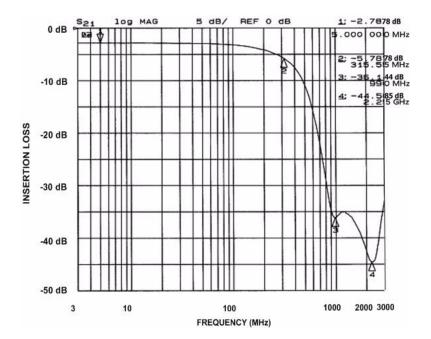
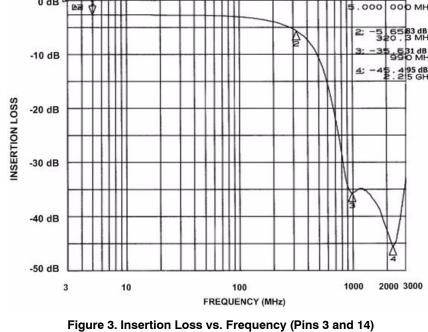


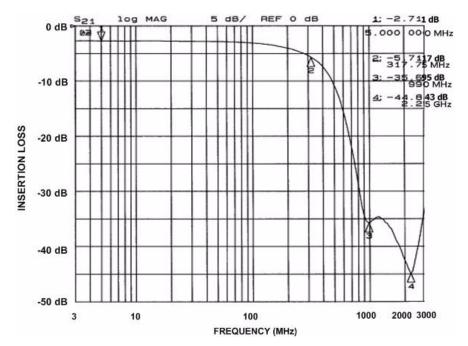
Figure 2. Insertion Loss vs. Frequency (Pins 2 and 15)

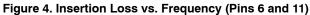
5 dB/ REF 0 dB 1: -2.5584 dB 109 MAG 52 0 dB 000 000 MHz (ba 6583 dB F 20 631 dB -10 dB 4: 4 95 dB -20 dB -30 dB -40 dB -50 dB 2000 3000 1000 3 10 100

PERFORMANCE INFORMATION (cont'd)



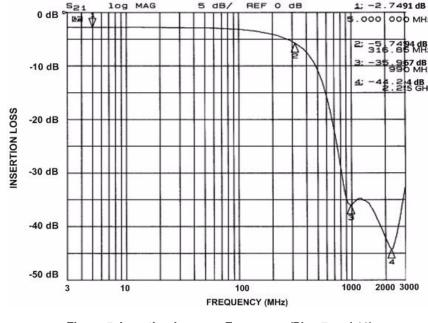
Typical Filter Performance (nominal conditions unless specified otherwise, 50 Ω Environment)



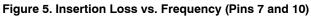


log MAG 5 dB/ REF 0 dB 1; -2.7491 dB S2 0 dB 000 000 MHz 13. 2: 85 MHz A 31 57 dB O MHz -10 dB 4: NO 4 dB -20 dB -30 dB -40 dB -50 dB 1000 2000 3000 10 100 3 FREQUENCY (MHz)

PERFORMANCE INFORMATION (cont'd)



Typical Filter Performance (nominal conditions unless specified otherwise, 50 Ω Environment)



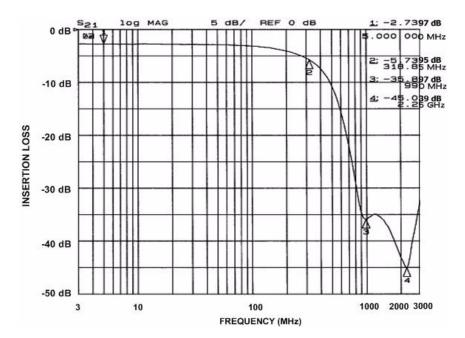
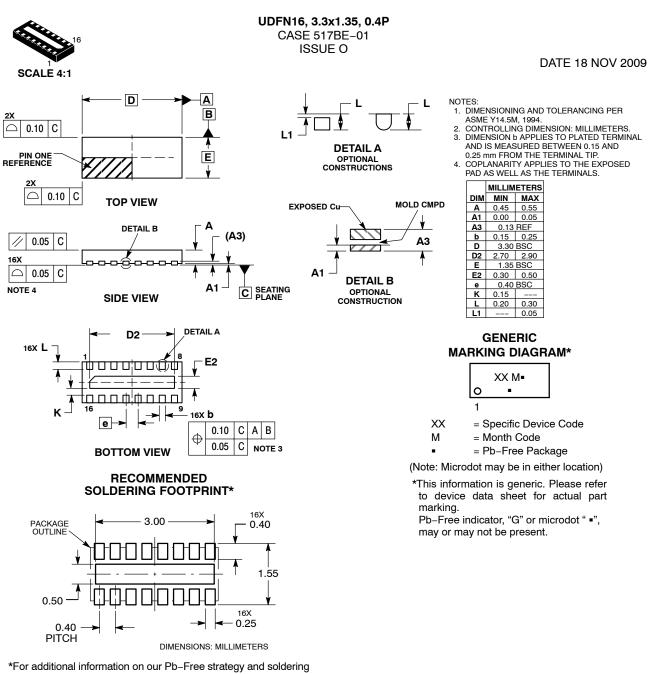


Figure 6. Insertion Loss vs. Frequency (Pins 8 and 9)





details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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 PAGE 1 OF 1

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